

SEMICONDUCTOR®

November 2013

FQPF13N06L

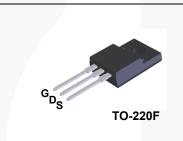
N-Channel QFET[®] MOSFET 60 V, 10 A, 110 m Ω

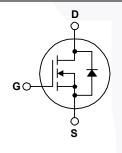
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 10 A, 60 V, $R_{DS(on)}$ = 110 m Ω (Max.) @ V_{GS} = 10 V, I_D = 5 A
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQPF13N06L	Unit
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°	°C)	10	A
	- Continuous (T _C = 100)°C)	7.1	A
I _{DM}	Drain Current - Pulsed	(Note 1)	40	A
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	90	mJ
I _{AR}	Avalanche Current	(Note 1)	10	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.4	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		24	W
	- Derate above 25°C		0.16	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

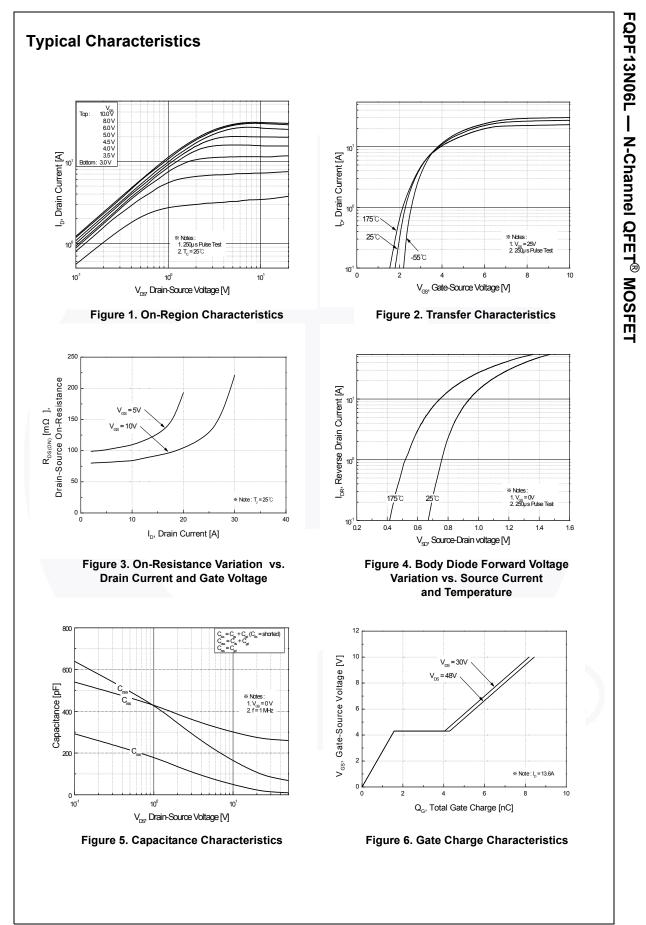
Thermal Characteristics

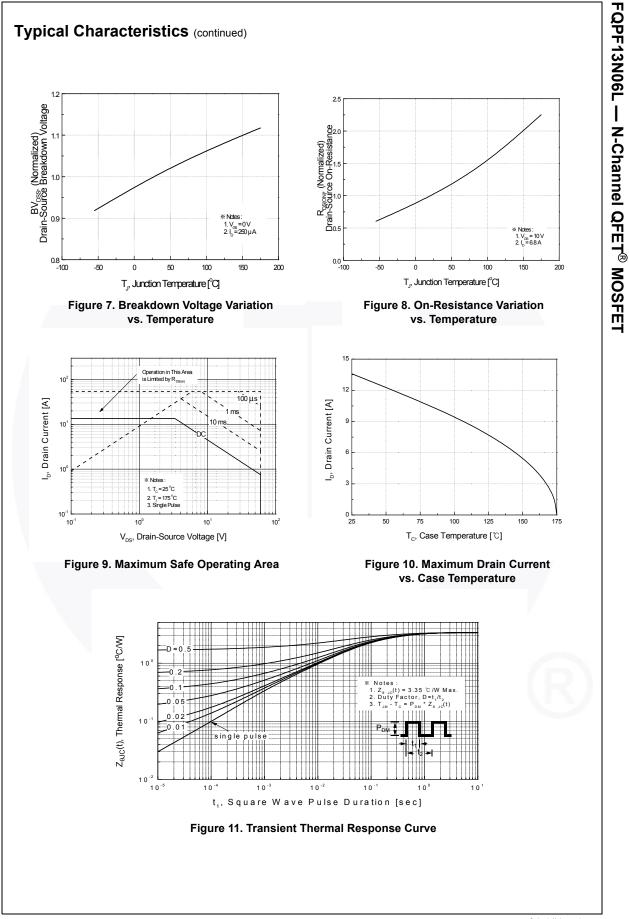
Symbol	Parameter	FQPF13N06L	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	6.20	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

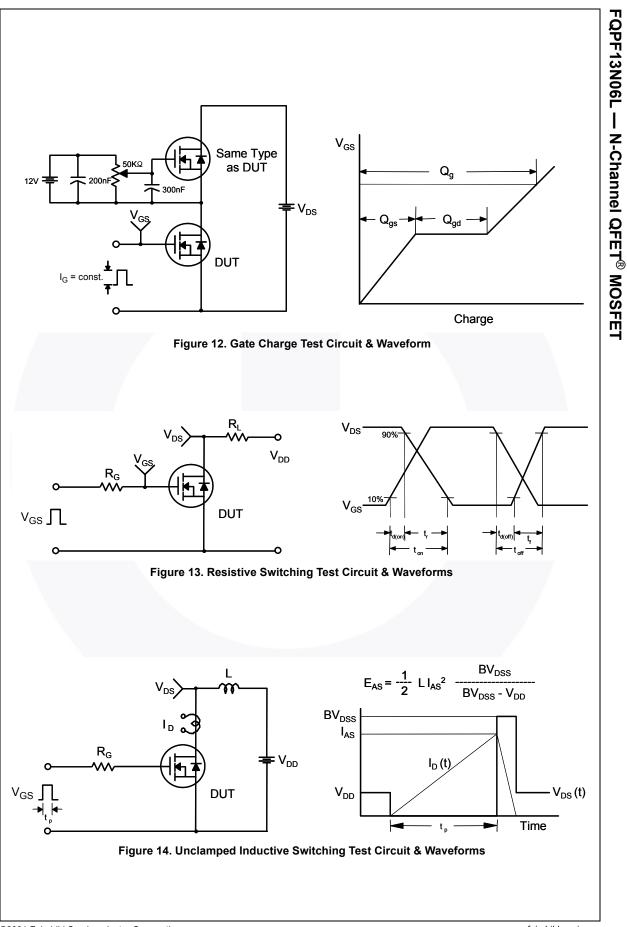
Part NumberTop MarkPackageFQPF13N06LFQPF13N06LTO-220F		Packing Method	Reel Size	Tape Width		h Q	Quantity		
		Tube N/A		N/A		5	50 units		
ectri	cal C	haracteristics	T _C = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Condit	ions	Min	Тур	Мах	Unit
Off Cha	aracto	ristics							
BV _{DSS}		Source Breakdown V	oltage	V _{GS} = 0 V, I _D = 250 μA		60			V
ΔBV_{DSS}			U			00			v
$\Delta T_{\rm J}$	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, Referenced to 25°C			0.05		V/°C	
IDSS				V _{DS} = 60 V, V _{GS} = 0 V				1	μA
	Zero C	Zero Gate Voltage Drain Current		$V_{DS} = 48 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$				10	μA
I _{GSSF}	Gate-	Body Leakage Curren	t, Forward	V _{GS} = 20 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$		V			-100	nA		
On Cha				N/ N/ 1 050			1		
V _{GS(th)}		Threshold Voltage		$V_{DS} = V_{GS}$, $I_D = 250 \mu A$		1.0		2.5	V
R _{DS(on)}		Drain-Source esistance		$V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ $V_{GS} = 5 \text{ V}, I_{D} = 5 \text{ A}$			0.088 0.110	0.11 0.14	Ω
9 _{FS}	Forwa	rd Transconductance		$V_{DS} = 25 V, I_D = 5 A$			5.5		S
	1	racteristics							
C _{iss}		Capacitance		V_{DS} = 25 V, V_{GS} = 0	V,		270	350	pF
C _{oss}		t Capacitance		f = 1.0 MHz			95	125	pF
C _{rss}	Reven	se Transfer Capacitar	nce				17	23	pF
Switch	ina Ch	aracteristics							
t _{d(on)}		On Delay Time			,)		8	25	ns
t _r		On Rise Time		V_{DD} = 30 V, I_D = 6.8 R _G = 25 Ω	А,		90	190	ns
t _{d(off)}	Turn-C	Off Delay Time		R _G = 23 32			20	50	ns
t _f	Turn-C	Off Fall Time			(Note 4)		40	90	ns
Q _g	Total C	Sate Charge		V _{DS} = 48 V, I _D = 13.6	6 A		4.8	6.4	nC
Q _{gs}	Gate-S	Source Charge		$V_{GS} = 5 V$ (Note 4)			1.6		nC
Q _{gd}	Gate-I	Drain Charge					2.7		nC
			1				1 1	1	
Drain-S	Source	Diode Characte	ristics an	d Maximum Rati	ngs				
I _S	Maximum Continuous Drain-Source Dio			de Forward Current				10	Α
sм	Maxim	num Pulsed Drain-Sou	Irce Diode Fo					40	Α
V _{SD}	Drain-	Source Diode Forwar	d Voltage	$V_{GS} = 0 V, I_S = 10 A$ $V_{GS} = 0 V, I_S = 13.6 A,$				1.5	V
t _{rr}	Reven	se Recovery Time					45		ns
Q _{rr}	Reven	se Recovery Charge		dI _F / dt = 100 A/µs			45		nC

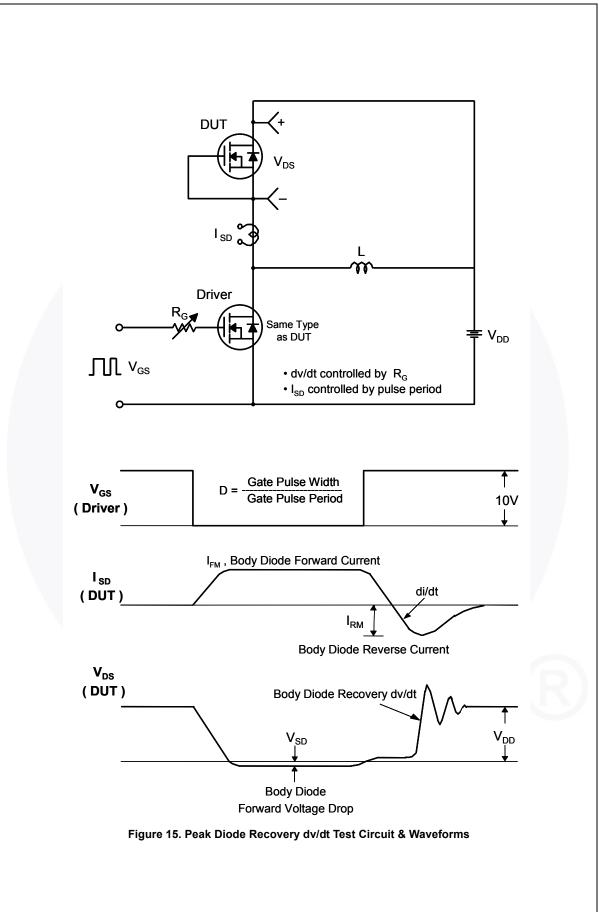
4. Essentially independent of operating temperature.

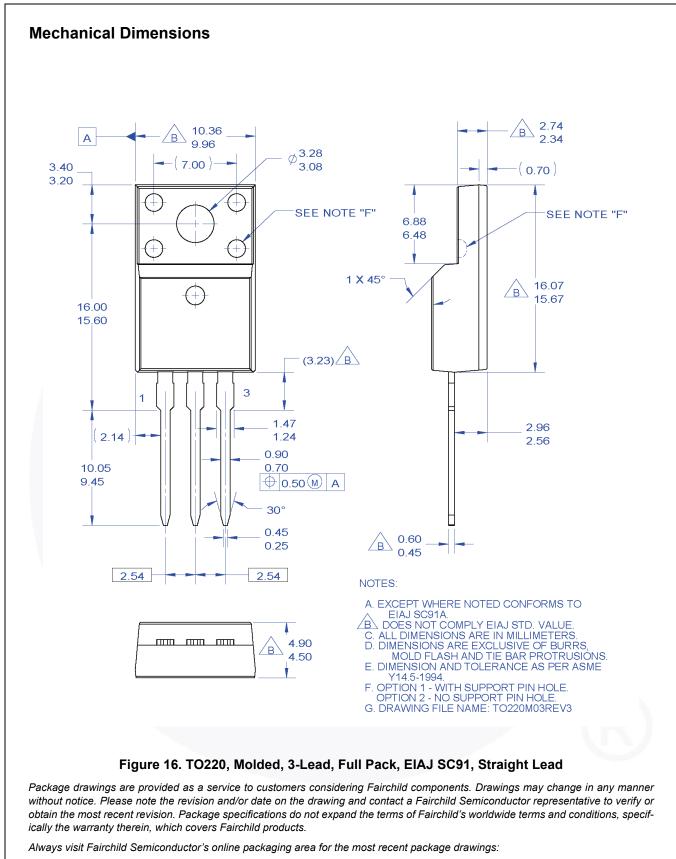
FQPF13N06L — N-Channel QFET[®] MOSFET











http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003

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